

MC14094B

8-Stage Shift/Store Register with Three-State Outputs

The MC14094B combines an 8-stage shift register with a data latch for each stage and a 3-state output from each latch.

Data is shifted on the positive clock transition and is shifted from the seventh stage to two serial outputs. The Q_5 output data is for use in high-speed cascaded systems. The Q_5 output data is shifted on the following negative clock transition for use in low-speed cascaded systems.

Data from each stage of the shift register is latched on the negative transition of the strobe input. Data propagates through the latch while strobe is high.

Outputs of the eight data latches are controlled by 3-state buffers which are placed in the high-impedance state by a logic Low on Output Enable.

Features

- 3-State Outputs
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky TTL Load Over the Rated Temperature Range
- Input Diode Protection
- Data Latch
- Dual Outputs for Data Out on Both Positive and Negative Clock Transitions
- Useful for Serial-to-Parallel Data Conversion
- Pin-for-Pin Compatible with CD4094B
- Pb-Free Packages are Available*

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

Symbol	Parameter	Value	Unit
V_{DD}	DC Supply Voltage Range	-0.5 to +18.0	V
V_{in}, V_{out}	Input or Output Voltage Range (DC or Transient)	-0.5 to $V_{DD} + 0.5$	V
I_{in}, I_{out}	Input or Output Current (DC or Transient) per Pin	± 10	mA
P_D	Power Dissipation, per Package (Note 1)	500	mW
T_A	Ambient Temperature Range	-55 to +125	$^{\circ}\text{C}$
T_{stg}	Storage Temperature Range	-65 to +150	$^{\circ}\text{C}$
T_L	Lead Temperature (8-Second Soldering)	260	$^{\circ}\text{C}$

1. Temperature Derating:
Plastic "P and D/DW" Packages: - 7.0 mW/ $^{\circ}\text{C}$ From 65 $^{\circ}\text{C}$ To 125 $^{\circ}\text{C}$

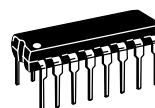
This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

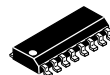
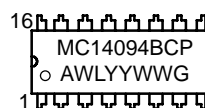


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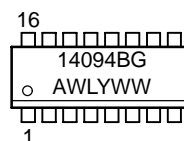
MARKING DIAGRAMS



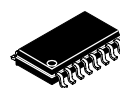
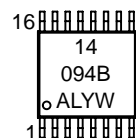
PDIP-16
P SUFFIX
CASE 648



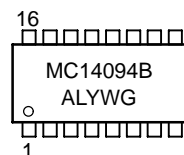
SOIC-16
D SUFFIX
CASE 751B



TSSOP-16
DT SUFFIX
CASE 948F



SOEIAJ-16
F SUFFIX
CASE 966



- A = Assembly Location
- WL, L = Wafer Lot
- YY, Y = Year
- WW, W = Work Week
- G = Pb-Free Indicator

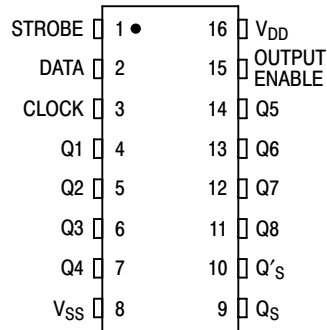
ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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PIN ASSIGNMENT



TRUTH TABLE

Clock	Output Enable	Strobe	Data	Parallel Outputs		Serial Outputs	
				Q ₁	Q _N	Q _S *	Q' _S
	0	X	X	Z	Z	Q ₇	No Chg.
	0	X	X	Z	Z	No Chg.	Q ₇
	1	0	X	No Chg.	No Chg.	Q ₇	No Chg.
	1	1	0	0	Q _{N-1}	Q ₇	No Chg.
	1	1	1	1	Q _{N-1}	Q ₇	No Chg.
	1	1	1	No Chg.	No Chg.	No Chg.	Q ₇

Z = High Impedance X = Don't Care

* At the positive clock edge, information in the 7th shift register stage is transferred to Q₈ and Q_S.

ORDERING INFORMATION

Device	Package	Shipping [†]
MC14094BCP	PDIP-16	500 Units / Rail
MC14094BCPG	PDIP-16 (Pb-Free)	500 Units / Rail
MC14094BD	SOIC-16	48 Units / Rail
MC14094BDG	SOIC-16 (Pb-Free)	48 Units / Rail
MC14094BDR2	SOIC-16	2500 Units / Tape & Reel
MC14094BDR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
MC14094BDTR2	TSSOP-16*	2500 Units / Tape & Reel
MC14094BF	SOEIAJ-16	50 Units / Rail
MC14094BFG	SOEIAJ-16 (Pb-Free)	50 Units / Rail
MC14094BFEL	SOEIAJ-16	2000 Units / Tape & Reel
MC14094BFELG	SOEIAJ-16 (Pb-Free)	2000 Units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*This package is inherently Pb-Free.

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ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic	Symbol	V_{DD} Vdc	- 55 °C		25 °C			125 °C		Unit	
			Min	Max	Min	Typ ⁽²⁾	Max	Min	Max		
Output Voltage $V_{in} = V_{DD}$ or 0	"0" Level V_{OL}	5.0	–	0.05	–	0	0.05	–	0.05	Vdc	
		10	–	0.05	–	0	0.05	–	0.05		
		15	–	0.05	–	0	0.05	–	0.05		
	"1" Level $V_{in} = 0$ or V_{DD}	V_{OH}	5.0	4.95	–	4.95	5.0	–	4.95		–
			10	9.95	–	9.95	10	–	9.95		–
			15	14.95	–	14.95	15	–	14.95		–
Input Voltage $(V_O = 4.5$ or 0.5 Vdc) $(V_O = 9.0$ or 1.0 Vdc) $(V_O = 13.5$ or 1.5 Vdc)	"0" Level V_{IL}	5.0	–	1.5	–	2.25	1.5	–	1.5	Vdc	
		10	–	3.0	–	4.50	3.0	–	3.0		
		15	–	4.0	–	6.75	4.0	–	4.0		
	"1" Level $(V_O = 0.5$ or 4.5 Vdc) $(V_O = 1.0$ or 9.0 Vdc) $(V_O = 1.5$ or 13.5 Vdc)	V_{IH}	5.0	3.5	–	3.5	2.75	–	3.5		–
			10	7.0	–	7.0	5.50	–	7.0		–
			15	11	–	11	8.25	–	11		–
Output Drive Current $(V_{OH} = 2.5$ Vdc) $(V_{OH} = 4.6$ Vdc) $(V_{OH} = 9.5$ Vdc) $(V_{OH} = 13.5$ Vdc)	Source I_{OH}	5.0	–3.0	–	–2.4	–4.2	–	–1.7	–	mAdc	
		5.0	–0.64	–	–0.51	–0.88	–	–0.36	–		
		10	–1.6	–	–1.3	–2.25	–	–0.9	–		
		15	–4.2	–	–3.4	–8.8	–	–2.4	–		
	Sink I_{OL}	5.0	0.64	–	0.51	0.88	–	0.36	–		
		10	1.6	–	1.3	2.25	–	0.9	–		
15	4.2	–	3.4	8.8	–	2.4	–	–			
Input Current	I_{in}	15	–	± 0.1	–	± 0.00001	± 0.1	–	± 1.0	μ Adc	
Input Capacitance $(V_{in} = 0)$	C_{in}	–	–	–	–	5.0	7.5	–	–	pF	
Quiescent Current (Per Package)	I_{DD}	5.0	–	5.0	–	0.005	5.0	–	150	μ Adc	
		10	–	10	–	0.010	10	–	300		
		15	–	20	–	0.015	20	–	600		
Total Supply Current ⁽³⁾ ⁽⁴⁾ (Dynamic plus Quiescent, Per Package) $(C_L = 50$ pF on all outputs, all buffers switching)	I_T	5.0	$I_T = (4.1 \mu\text{A/kHz}) f + I_{DD}$							μ Adc	
		10	$I_T = (14 \mu\text{A/kHz}) f + I_{DD}$								
		15	$I_T = (140 \mu\text{A/kHz}) f + I_{DD}$								
3-State Output Leakage Current	I_{TL}	15	–	± 0.1	–	± 0.0001	± 0.1	–	± 3.0	μ A	

2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

3. The formulas given are for the typical characteristics only at 25 °C.

4. To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) Vfk$$

where: I_T is in μ A (per package), C_L in pF, $V = (V_{DD} - V_{SS})$ in volts, f in kHz is input frequency, and $k = 0.001$.

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SWITCHING CHARACTERISTICS ⁽⁵⁾ ($C_L = 50 \text{ pF}$, $T_A = 25^\circ\text{C}$)

Characteristic	Symbol	V _{DD} Vdc	Min	Typ ⁽⁶⁾	Max	Unit
Output Rise and Fall Time $t_{TLH}, t_{THL} = (1.35 \text{ ns/pF}) C_L + 33 \text{ ns}$ $t_{TLH}, t_{THL} = (0.6 \text{ ns/pF}) C_L + 20 \text{ ns}$ $t_{TLH}, t_{THL} = (0.4 \text{ ns/pF}) C_L + 20 \text{ ns}$	$t_{TLH},$ t_{THL}	5.0 10 15	- - -	100 50 40	200 100 80	ns
Propagation Delay Time Clock to Serial out QS $t_{PLH}, t_{PHL} = (0.90 \text{ ns/pF}) C_L + 305 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.36 \text{ ns/pF}) C_L + 107 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.26 \text{ ns/pF}) C_L + 82 \text{ ns}$ Clock to Serial out Q'S $t_{PLH}, t_{PHL} = (0.90 \text{ ns/pF}) C_L + 350 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.36 \text{ ns/pF}) C_L + 149 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.26 \text{ ns/pF}) C_L + 62 \text{ ns}$ Clock to Parallel out $t_{PLH}, t_{PHL} = (0.90 \text{ ns/pF}) C_L + 375 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.35 \text{ ns/pF}) C_L + 177 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.26 \text{ ns/pF}) C_L + 122 \text{ ns}$ Strobe to Parallel out $t_{PLH}, t_{PHL} = (0.90 \text{ ns/pF}) C_L + 245 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.36 \text{ ns/pF}) C_L + 127 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.26 \text{ ns/pF}) C_L + 87 \text{ ns}$	$t_{PLH},$ t_{PHL}	5.0 10 15	- - -	350 125 95	600 250 190	ns
	$t_{PHZ},$ t_{PZL}	5.0 10 15	- - -	140 75 55	280 150 110	
	$t_{PLZ},$ t_{PZH}	5.0 10 15	- - -	225 95 70	450 190 140	
Setup Time Data in to Clock	t_{su}	5.0 10 15	125 55 35	60 30 20	- - -	
Hold Time Clock to Data	t_h	5.0 10 15	0 20 20	-40 -10 0	- - -	
Clock Pulse Width, High	t_{WH}	5.0 10 15	200 100 83	100 50 40	- - -	ns
Clock Rise and Fall Time	$t_{r(cl)}$ $t_{f(cl)}$	5 10 15	- - -	- - -	15 5.0 4.0	
Clock Pulse Frequency	f_{cl}	5.0 10 15	- - -	2.5 5.0 6.0	1.25 2.5 3.0	MHz
Strobe Pulse Width	t_{WL}	5.0 10 15	200 80 70	100 40 35	- - -	

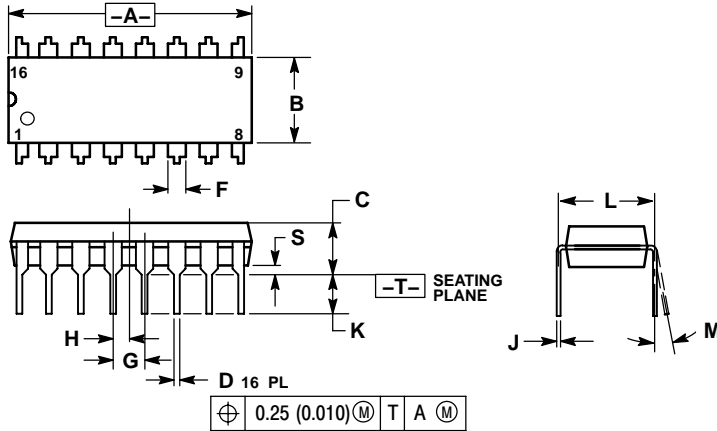
5. The formulas given are for the typical characteristics only at 25°C.

6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

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PACKAGE DIMENSIONS

PDIP-16
P SUFFIX
PLASTIC DIP PACKAGE
CASE 648-08
ISSUE T

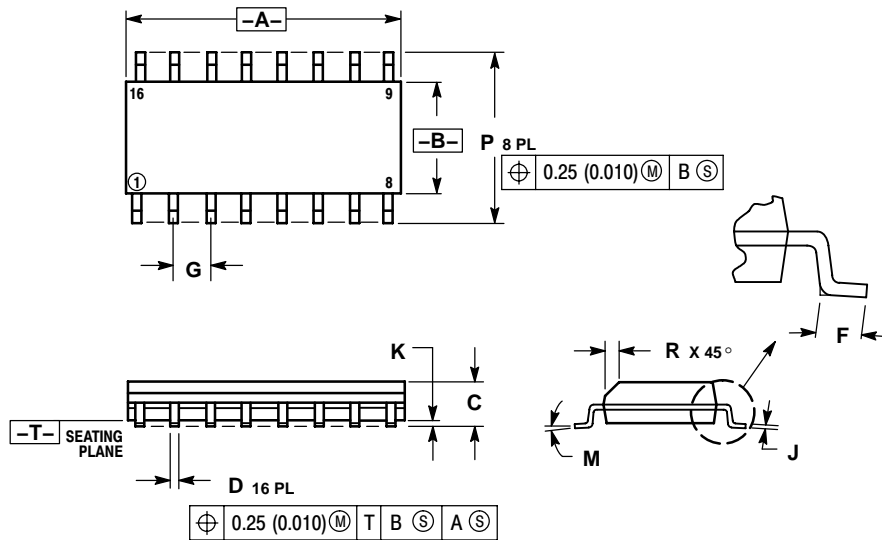


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

SOIC-16
D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751B-05
ISSUE J



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019